ECO MODEL conga-ELX



ETX® Spec 2.7

- Low power consumption
- Featuring AMD® Geode® LX800
- Up to 1 GByte DRAM

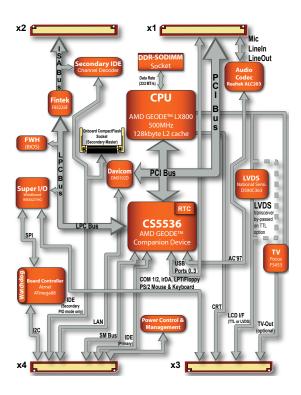


CPU	MD Geode™ LX 800 Processor 400 MT/s memory bus speed 128 kByte L2 Cache				
DRAM	SO-DIMM PC2700 up to 1 GByte				
Chipset	Companion Device: AMD Geode™ CS5536 Ethernet: Davicom DM9102D I/O Controller: Winbond 83627HG Audio Codec: ALC203				
Ethernet	IEEE 802.3u 100Base-Tx Fast Ethernet compatible				
I/O Interfaces	1x EIDE (UDMA-66/100) primary 1x IDE (PIO mode only) secondary 1x CompactFlash Socket onboard 4x USB 2.0 (EHCl) PCI Bus Rev. 2.1 ISA Bus I ² C (Fast Mode / 400 kHz / Multi Master) Floppy (Shared with LPT) LPT (EPP/ECP / Shared with Floppy) 2x COM Ports TTL Level 1x IrDA Port PS/2 Keyboard Mouse				
Sound	AC'97 Rev.2.2 compatible Line In Line Out Mic In				
Graphics	Integrated in chipset up to 254 MByte graphic memory (UMA)				
Motion Video Support	H/W Up- and Downscaling High Definition digital video support alpha blending and color keying				
Flat panel Interface	68 MHz LVDS Transmitter Automatic Panel Detection via EPI Embedded Panel Interface based on VESA EDID™ 1.3 1x18 Bit TFT resolutions 320x240 u to 1024x768 optional direct TTL interface				
CRT Interface	350 MHz RAMDAC Resolutions up to 1920x1440x32bpp @ 85 Hz 1600x1200x32bpp @ 100 Hz				
TV Out	Optional onboard TV encoder supports HDTV (420p / 720p / 1080i) supports component- and s-video signals on ETX X3 connector				
congatec Board Controller	Multi Stage Watchdog Non-volatile User Data Storage Manufacturing and Board information Board Statistics BIOS Setup Data Backup I ² C (Fast Mode / 400 kHz / Multi Master) Power Loss Contro				
Embedded BIOS Features	OEM Logo OEM CMOS Defaults LCD Control (Auto Detection / Backlight Control) Flash Update Based on Insyde XpressROMt				
Power Management	APM 1.2				
Operating Systems	Microsoft® Windows CE 6.0 Microsoft® Windows XP Microsoft® Windows® embedded Standard Linux				
Power Consumption	Typ. application 5W @ 5V see manual for full details CMOS Battery Backup				
Temperature	Operating: 0 +60°C Storage: -20 +80°C				
Humidity	Operating: 10 - 90% r. H. non cond. Storage: 5 - 95% r. H. non cond.				
Size	95 x 114 mm (3.7" x 4.5").				



Formfactor

conga-ELX| Block diagram



conga-ELX | Order Information

Article	PN	Description
conga-ELX/800-LVDS	024477	ETX Module with AMD Geode LX800 and AMD companion chip CS5536 Processor 500MHz LVDS graphics-interface
conga-ELX/800-TTL	064987	ETX Module with AMD Geode LX800 and AMD companion chip CS5536 Processor 500MHz TTL graphics-interface
conga-ELX/DD-HSP-B	045458	Heatspreader (Deep drawn stamped) for conga-ELX and ELXeco with 2.7mm bore hole
conga-ELX/DD-HSP-T	066558	Heatspreader (Deep drawn stamped) for conga-ELX and ELXeco with 2.5mm thread
DDR1-SODIMM-333 (256MB)	068721	DDR1 SODIMM memory module with 333MT/s and 256MB RAM

Accessories

conga-EEVAL	033269	Evaluation carrier board for ETX-modules
conga-FPA2	047250	Flatpanel prototype adapter to develop your own flatpanel adapter Including cables set.
XTX/ETX-carrierboard- socket-3	400006	Connector for ETX and XTX carrier boards height 3.0 mm packing unit 8 pieces
XTX/ETX-carrierboard- socket-9.5	400009	Connector for ETX and XTX carrier boards height 9.5 mm packing unit 8 pieces

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